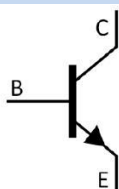


/ Descriptions

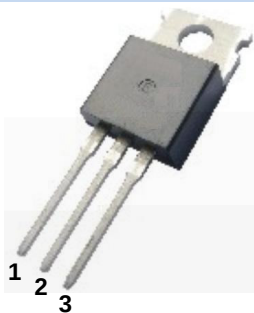
/ Features

/ Applications

/ Equivalent Circuit



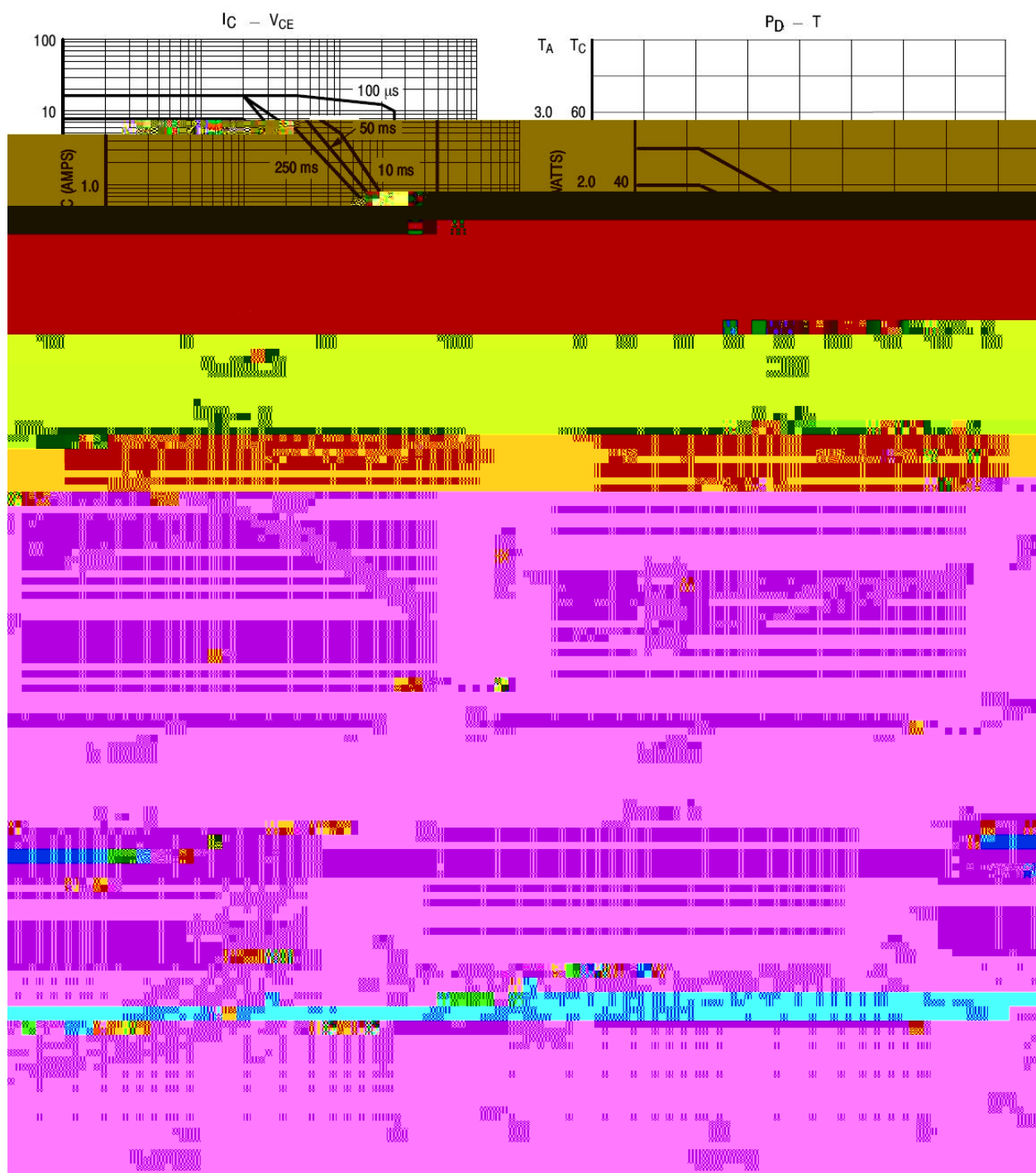
/ Pinning



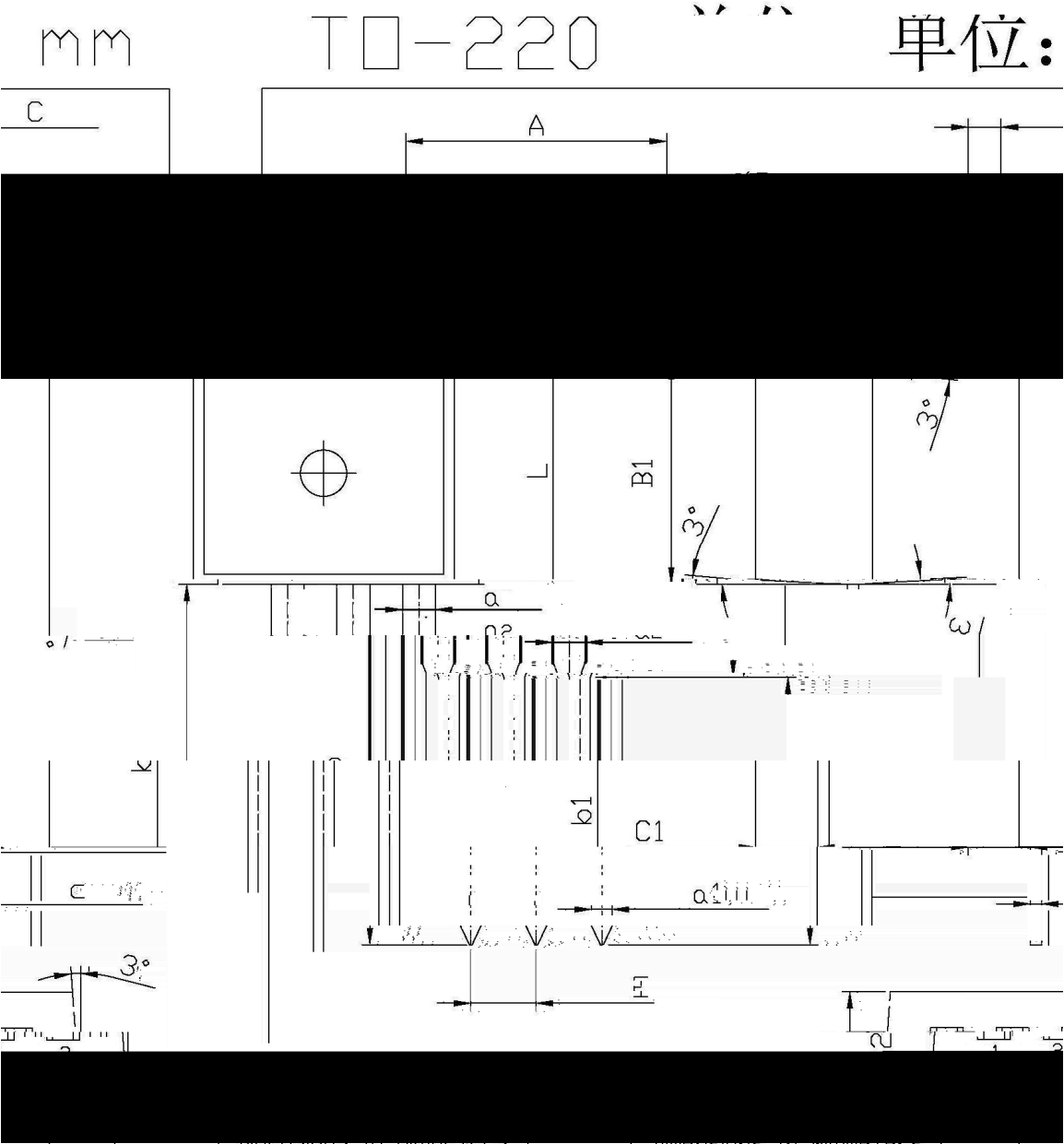
/ h_{FE} Classifications & Marking

	θ		

/ Electrical Characteristic Curve

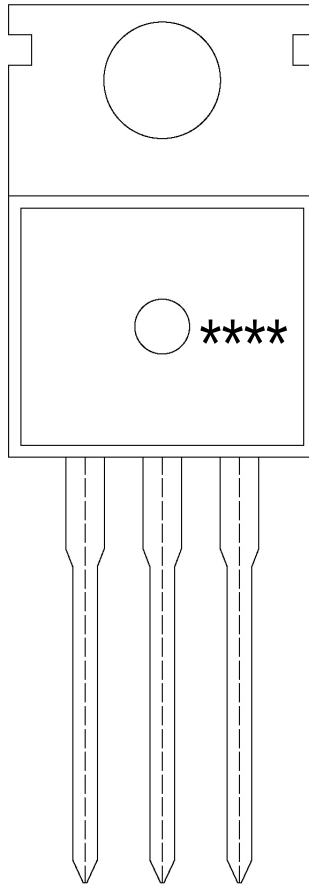


/ Package Dimensions

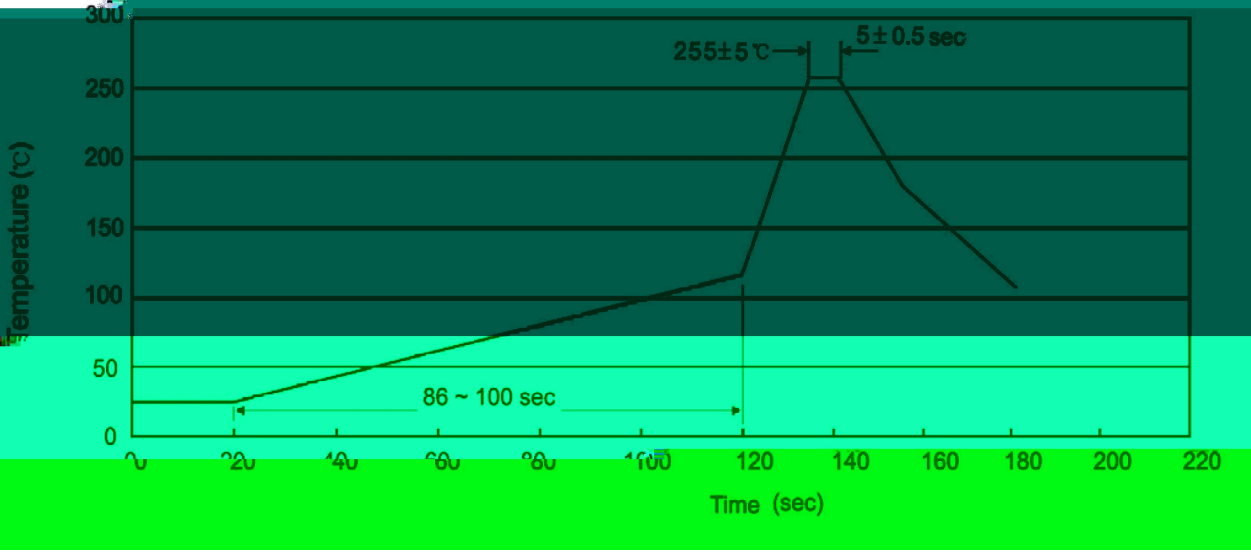


Dimensions in Millimeters			Dimensions in Millimeters		
Symbol	Min	Max	Symbol	Min	Max
A	9.8	10.2	C	1.2	1.4
B	3.56	3.64	B1	6.3	6.7
C1	0.4	0.6	a	1.22	1.32
a1	1.73	1.77	b1	2.34	2.74
				0.2	1.25
					1.45

/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

		包装数量		包装尺寸	
封装形式	Units/Bag 只/袋	Bags/Inner Box 袋/盒	Units/Inner Box 只/盒	InoTMM/OutM4	